Ultra High Performance BGA Cooling Solutions w/ maxiGRIP™ Attachment*

DIGI-KEY PART # ATS1036-ND

ATS PART # ATS-50250P-C2-R0

Features & Benefits

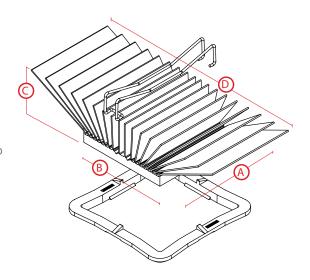
maxiFLOW™ design features a low profile, spread fin array that maximizes surface area for more effective convection (air) cooling

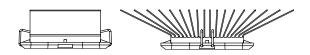
maxiGRIP™ attachment applies steady, even pressure to the component and does not require holes in the PCB

Meets Telcordia GR-63-Core Office Vibration; ETSI 300 019 Transportation Vibration; and MIL-STD-810 Shock and Unpackaged Drop Testing standards

Comes preassembled with high performance, phase changing, thermal interface material

Designed for standard height components from 3 to 4.5mm





Thermal Performance Table

| AIR VELOCITY | | THERMAL RESISTANCE | | |
|--------------|-----|--------------------|---------------|--|
| FT/MIN | M/S | °C/W (UNDUCTED) | °C/W (DUCTED) | |
| 200 | 1.0 | 3.9 | 3 | |
| 300 | 1.5 | 3.2 | | |
| 400 | 2.0 | 2.7 | | |
| 500 | 2.5 | 2.5 | | |
| 600 | 3.0 | 2.3 | | |
| 700 | 3.5 | 2.1 | | |
| 800 | 4.0 | 2 | | |

Product Details†

| DIMENSION A | DIMENSION B | DIMENSION C [§] | DIMENSION D | TIM [‡] | FINISH |
|-------------|-------------|--------------------------|-------------|------------------|---------------|
| 25 | 25 | 17.5 | 44.92 | C1100F | BLUE-ANODIZED |

For further technical information, please contact Advanced Thermal Solutions, Inc. at **1-781-769-2800** or **www.qats.com**

- * RoHS Compliant
- ‡ TIM = Thermal Interface Material
- † Dimensions are measured in millimeters
- ◆ Dimensions A & B refer to component size
- § Dimension C = the height of the heat sink shown above and does not include the height of the attachment method



